

Features

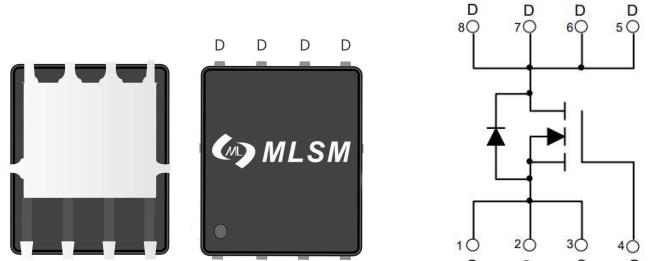
- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent dV/dt effect decline
- Green Device Available

Application

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

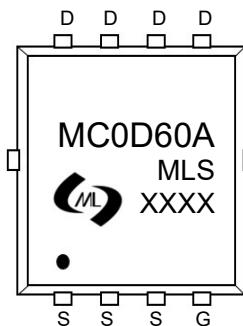
Product Summary

V_{DS}	$R_{DS(ON)} \text{ MAX}$	$I_D \text{ MAX}$
30V	7.5mΩ@10V	60A
	12mΩ@4.5V	



PDFN5X6-8L view

Schematic diagram


MC0D60A: Device code
XXXX : Code

Marking and pin assignment



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V_{DS}	Drain-Source Breakdown Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	60	A
Mounted on Large Heat Sink			
I_{DM}	Pulse Drain Current Tested	210	A
I_D	Continuous Drain Current	60	A
P_D	Maximum Power Dissipation	35	W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	80	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MC0D60A	PDFN5X6-8L	MC0D60A	5,000	10,000	70,000	13"reel

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	--	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.5	2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A	--	6.0	7.5	mΩ
		V _{GS} =4.5V, I _D =15A	--	7.8	12	mΩ

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

C _{ISS}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	--	1300	--	pF
C _{OSS}	Output Capacitance		--	180	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	110	--	pF

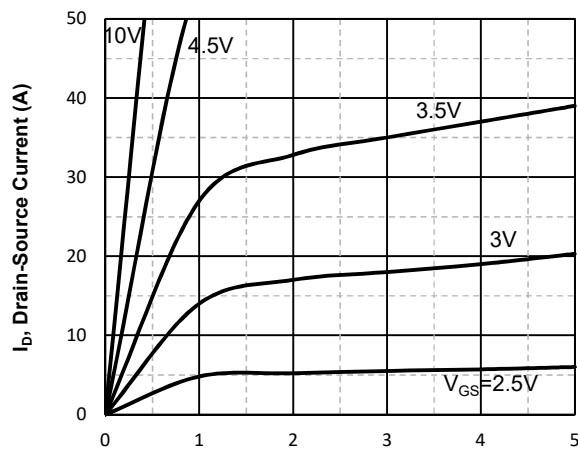
Switching Characteristics

Q _g	Total Gate Charge	V _{DS} =20V, I _D =20A, V _{GS} =4.5V	--	14	--	nC
Q _{gs}	Gate Source Charge		--	3.5	--	nC
Q _{gd}	Gate Drain Charge		--	7	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =12V, I _D =20A, V _{GS} =10V, R _G =3.3Ω	--	5	--	nS
t _r	Turn-on Rise Time		--	12	--	nS
t _{d(off)}	Turn-Off Delay Time		--	27	--	nS
t _f	Turn-Off Fall Time		--	10	--	nS

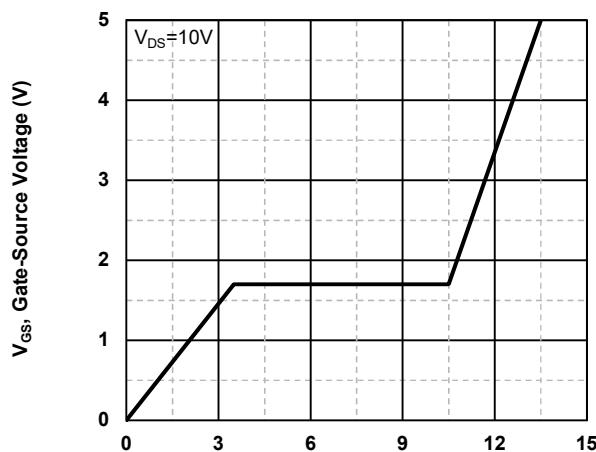
Source-Drain Diode Characteristics

V _{SD}	Forward on voltage	T _J =25°C, I _S =20A	--	--	1.2	V
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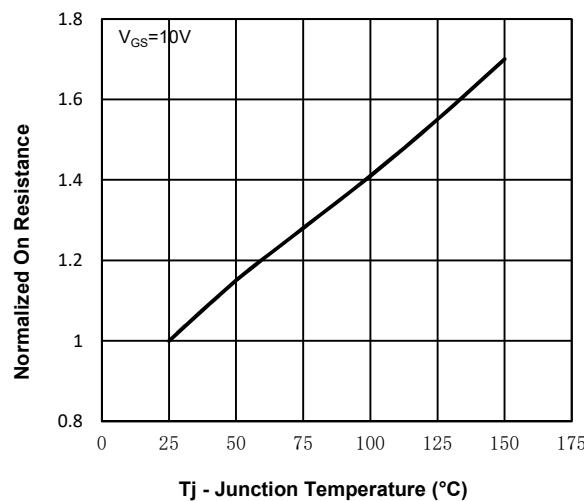
Typical Operating Characteristics



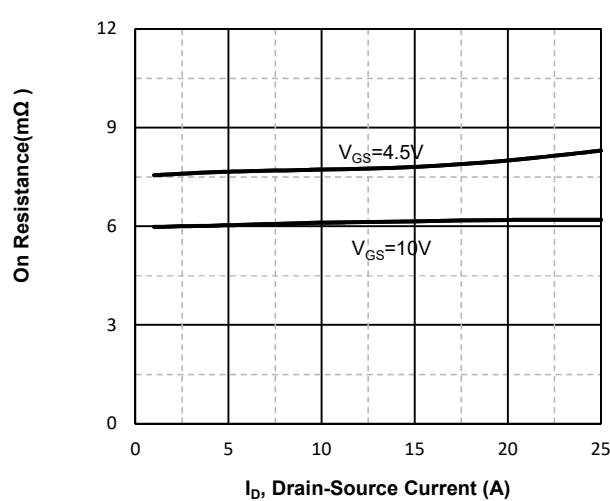
V_{DS} , Drain -Source Voltage (V)
Fig1. Typical Output Characteristics



Q_g -Total Gate Charge (nC)
Fig2. Typical Gate Charge Vs.Gate-Source Voltage



T_j - Junction Temperature (°C)
Fig3. Normalized On-Resistance Vs. Temperature



I_D , Drain-Source Current (A)
Fig4. On-Resistance Vs. Drain-Source Current

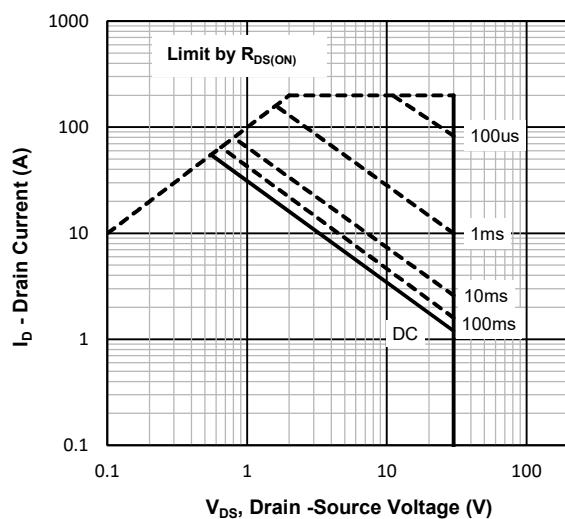


Fig5. Maximum Safe Operating Area

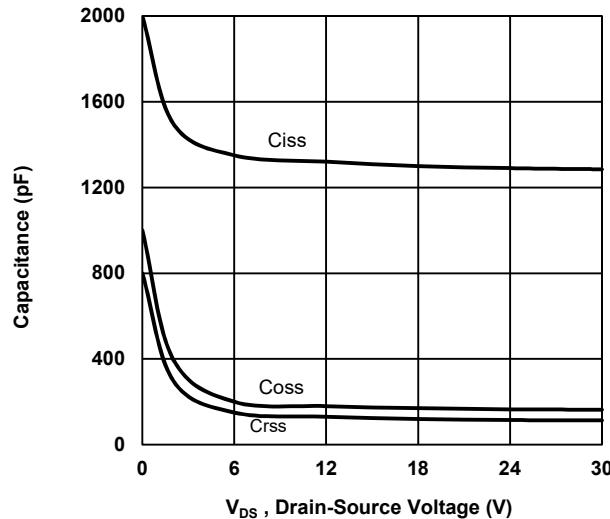
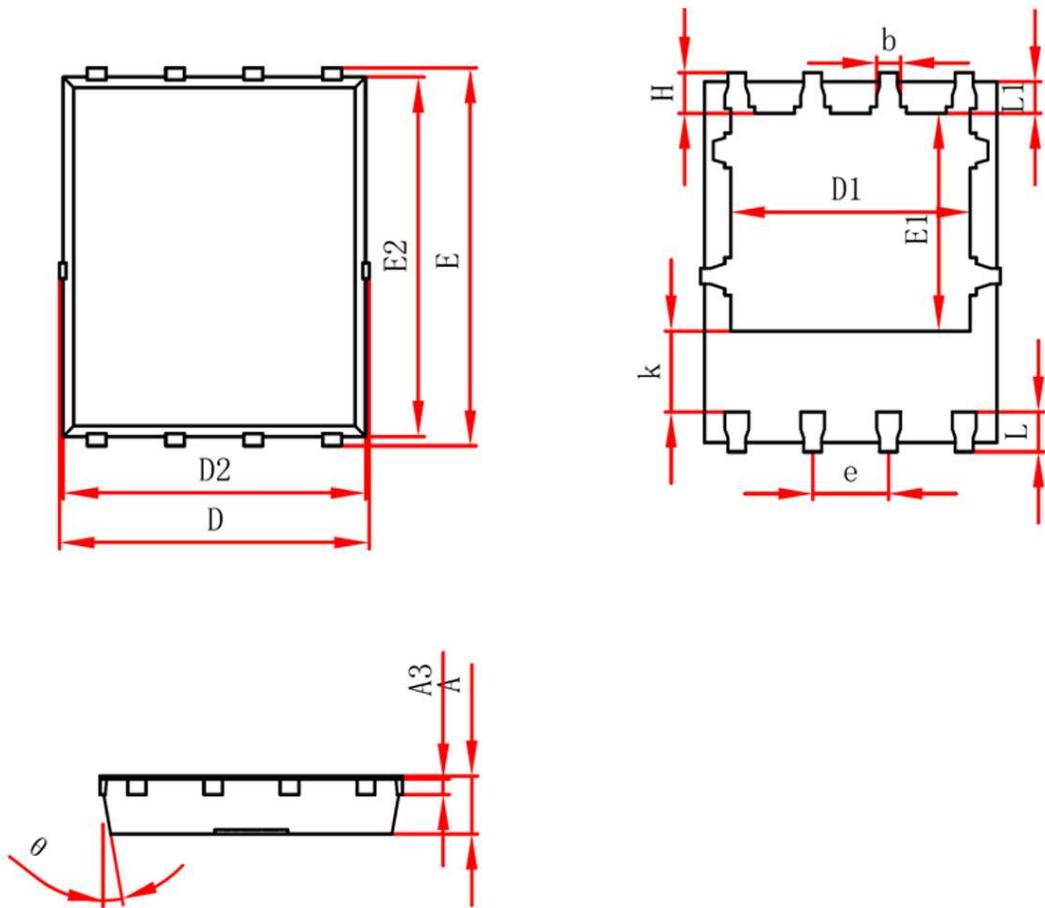


Fig6 Typical Capacitance Vs.Drain-Source

PDFN5X6-8L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.950	1.050	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.950	5.050	0.196	0.200
E	5.950	6.050	0.235	0.239
D1	4.026	4.126	0.159	0.163
E1	3.510	3.610	0.139	0.143
D2	4.850	4.950	0.192	0.196
E2	5.700	5.800	0.225	0.229
k	1.190	1.390	0.047	0.055
b	0.300	0.400	0.012	0.016
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°